



DMN67D8LW

### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C
60V	5.0Ω @ V <sub>GS</sub> = 10V	240mA
000	7.5Ω @ V <sub>GS</sub> = 5V	190mA

### Description

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(ON)})$  and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Applications**

- Motor Control
- Power Management Functions
- Backlighting

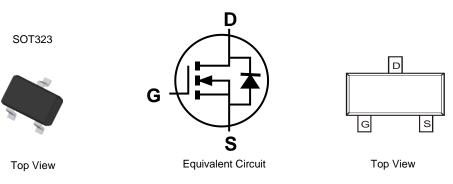
### N-CHANNEL ENHANCEMENT MODE MOSFET

### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

## **Mechanical Data**

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding
  Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208 3
- Weight: 0.006 grams (Approximate)



### Ordering Information (Note 4)

Part Number	Case	Packaging
DMN67D8LW-7	SOT323	3000/Tape & Reel
DMN67D8LW-13	SOT323	10000/Tape & Reel

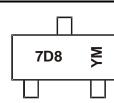
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

 See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



7D8= Product Type Marking Code YM or  $\overline{Y}$ M = Date Code Marking Y or  $\overline{Y}$  = Year (ex: B = 2014) M = Month (ex: 9 = September)

#### Date Code Key

Notes:

Year	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025
Code	В	С	D	E	F	G	Н		J	K	L	М
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	60	V	
Gate-Source Voltage			V <sub>GSS</sub>	±30	V
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	ID	240 180	mA		
Maximum Continuous Body Diode Forward Currer	nt (Note 6)	I <sub>S</sub>	0.5	A	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	%) (Note 6	)	I <sub>DM</sub>	0.8	A

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	320	mW
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>0JA</sub>	398	°C/W
Total Power Dissipation (Note 6)		PD	470	mW
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R <sub>θJA</sub>	273	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

R				1		
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	—	—	V	$V_{GS} = 0V, I_D = 10\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>			1.0	μA	$V_{DS} = 60V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	—	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.0		2.5	V	$V_{DS} = 10V, I_D = 250\mu A$
Static Drain-Source On-Resistance	D		1.5	5.0	Ω	$V_{GS} = 10V, I_D = 0.5A$
	R <sub>DS(ON)</sub>	_	3.2	7.5	12	$V_{GS} = 5V, I_D = 0.05A$
Forward Transfer Admittance	Y <sub>fs</sub>	80		_	mS	V <sub>DS</sub> =10V, I <sub>D</sub> = 0.2A
Diode Forward Voltage	V <sub>SD</sub>	_	0.78	1.5	V	$V_{GS} = 0V, I_{S} = 115mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	22	_	pF	
Output Capacitance	Coss	-	4.1	_	pF	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V f = 1.0MHz
Reverse Transfer Capacitance	Crss		2.5	_	pF	1 = 1.000112
Gate Resistance	Rg	-	120	_	Ω	$f = 1.0MHz$ , $V_{GS} = 0V$ , $V_{DS} = 0V$
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg		361		рС	
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	821	_	рС	V <sub>GS</sub> = 4.5V, V <sub>DS</sub> = 10V,
Gate-Source Charge	Q <sub>gs</sub>	-	162		рС	I <sub>D</sub> = 250mA
Gate-Drain Charge	Q <sub>gd</sub>	_	116	_	рС	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	2.8	_	ns	
Turn-On Rise Time	t <sub>R</sub>		3.0	—	ns	$V_{DD} = 30V, I_D = 0.2A,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	7.6	—	ns	$R_L = 150\Omega, V_{GS} = 10V, R_G = 25\Omega$
Turn-Off Fall Time	t <sub>F</sub>		5.6	—	ns	1

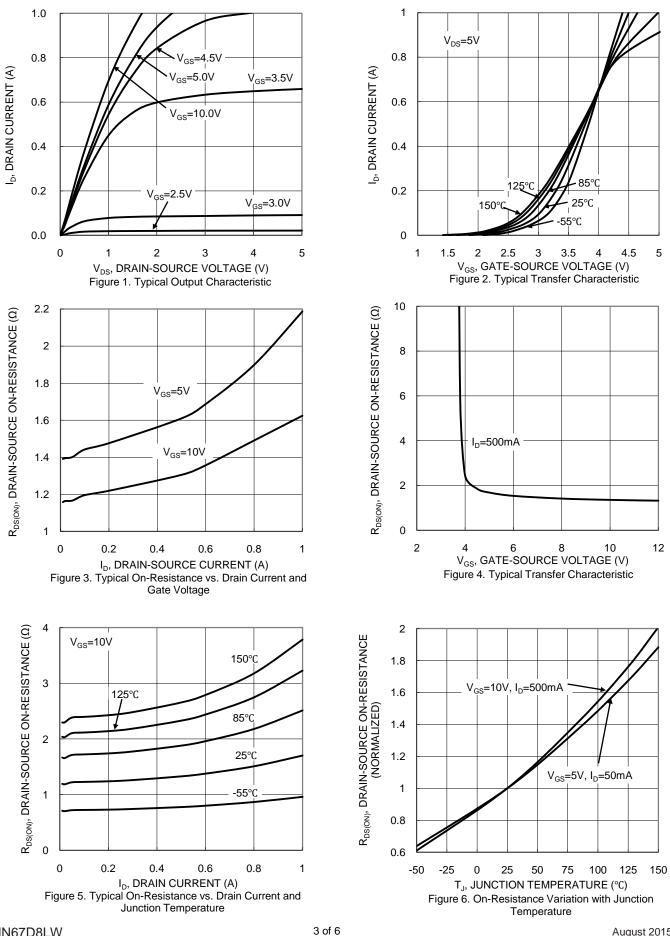
Notes: 5. Device mounted on FR-4 PCB, with minimum recommended pad layout

Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided.
 Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.



## DMN67D8LW



DMN67D8LW Document number: DS38030 Rev. 1 - 2

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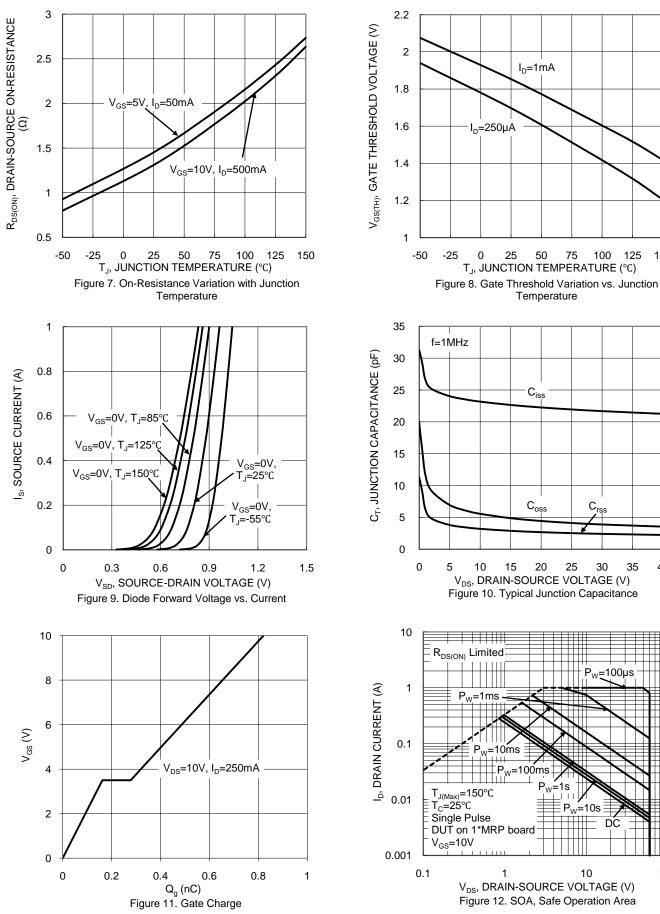
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125

35

40

150



NEW PRODUCT

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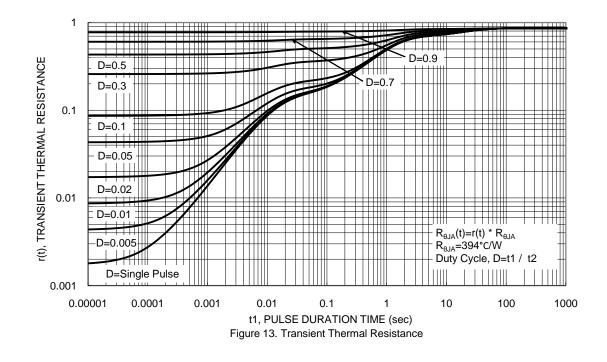
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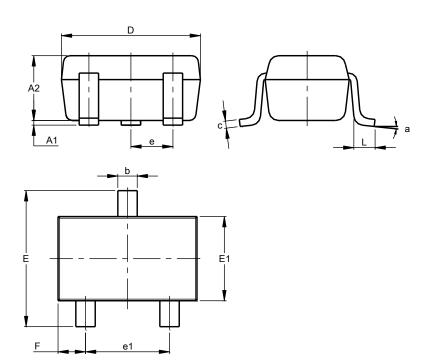
DC





# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

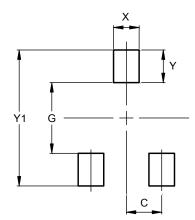


SOT323								
Dim	Min Max Typ							
A1	0.00	0.10	0.05					
A2	0.90	1.00	0.95					
b	0.25	0.40	0.30					
c	0.10	0.18	0.11					
D	1.80	2.20	2.15					
Е	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
е	C	).650 B	SC					
e1	1.20	1.40	1.30					
F	0.375	0.475	0.425					
L	0.25	0.40	0.30					
а		8°						
All	Dimen	sions i	in mm					



# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.650
G	1.300
X	0.470
Y	0.600
Y1	2.500

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